

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4882135

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JEFFRY HARLOW LOUCKS	09/14/2001
RECEIVING PARTY DATA	
Name:	PALM, INC.
Street Address:	5470 GREAT AMERICA PARKWAY
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95052
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	7505280
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	themisc@qualcomm.com
Correspondent Name:	THEMIS CHRYSSTOMIDES
Address Line 1:	5775 MOREHOUSE DRIVE
Address Line 4:	SAN DIEGO, CALIFORNIA 92121
ATTORNEY DOCKET NUMBER:	142924D1
NAME OF SUBMITTER:	THEMIS CHRYSSTOMIDES
SIGNATURE:	/Themis Chryssostomides/
DATE SIGNED:	03/23/2018
Total Attachments: 1	
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Assignment to Palm, Inc.

In consideration of good and valuable consideration, receipt of which is hereby acknowledged, I/we

Jeffrey Harlow Loucks

do hereby sell, assign and transfer unto Palm, Inc. (hereinafter called Palm, Inc.), a California Corporation having its principal place of business at 5470 Great America Parkway, Santa Clara, California 95052, and its successors and assigns, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

SUCCESSIVELY LAYERED MODULAR CONSTRUCTION FOR A PORTABLE COMPUTER SYSTEM

filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore; or

Serial No.: _____ filed on _____ and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore;

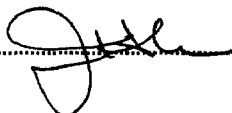
Further, I/we have agreed to assign to Palm, Inc. all inventions (except as otherwise limited by law) which relate to Palm, Inc. business and which were first conceived or actually reduced to practice during my/our employment by Palm, Inc.;

And for the above consideration, I/we agree promptly upon request of Palm, Inc., its successors or assigns, to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional or reissue, or other papers which may be necessary or desirable fully to secure to Palm, Inc., its successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by Palm, Inc.;

I/we further covenant with Palm, Inc., its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned;

In witness whereof, I/we hereunto set my/our hand(s) and seal.

Inventor's Signature: _____



Date: _____

JHL
~~8/~~ 9/14/01